

Lead free solder paste 600g, Sn96,5Ag3Cu0,5



- Solder paste NO-CLEAN
- Solder paste for stencil printing
- Grain size 3

[<https://www.tamura-elsold.de/index.php/en/downloads/safety-data-sheets-sds>Please download here the suitable safety data sheet]

Item no.	WL30141
Model	Pastentyp AP-40
Manufacturer	TAMURA ELSOLD
Manufacturer article no.	LOTPAST6015
GPSR manufacturer data	TAMURA DEUTSCHLAND GmbH Hüttenstraße 1 DE-38871 Ilsenburg

Products for the electronic industry



www.tamura-elsold.de

Sales unit	1 cartridge
Content unit	600 g
Detail content unit	600 g
Classification	DIN EN61190-1-1 RELO
Alloy	Sn96,5Ag3Cu0,5
Lead-free/lead-containing	lead free
Metal content	88.5 %
Metal powder size	25 – 45 µm

